# SVF840T-VB Datasheet

## N-Channel 500V (D-S)Power MOSFET

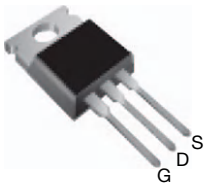
| PRODUCT SUMMARY | | |
|---|---|---|
| $V_{DS}$ (V) | 500 | |
| $R_{DS(on)}$ (Ω) | $V_{GS}$ = 10 V | 0.660 |
| $Q_g$ (Max.) (nC) | 81 | |
| $Q_{gs}$ (nC) | 20 | |
| $Q_{gd}$ (nC) | 36 | |
| Configuration | Single | |

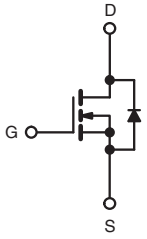
### FEATURES

- Lower Gate Charge $Q_g$ Results in Simpler Drive Reqirements
- Improved Gate, Avalanche and Dynamic dV/dt Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage
- Compliant to RoHS Directive 2002/95/EC

RoHS

TO-220AB




N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS ($T_C$ = 25 °C, unless otherwise noted) | | | | | |
|---|---|---|---|---|---|
| PARAMETER | | | SYMBOL | LIMIT | UNIT |
| Drain-Source Voltage | | | $V_{DS}$ | 500 | V |
| Gate-Source Voltage | | | $V_{GS}$ | ± 20 | |
| Continuous Drain Current | $V_{GS}$ at 10 V | $T_C$ = 25 °C | $I_D$ | 13 | A |
| | | $T_C$ = 100 °C | | 8.1 | |
| Pulsed Drain Current[a] | | | $I_{DM}$ | 50 | |
| Linear Derating Factor | | | | 2.0 | W/°C |
| Single Pulse Avalanche Energy[b] | | | $E_{AS}$ | 560 | mJ |
| Avalanche Current[a] | | | $I_{AR}$ | 13 | A |
| Repetitive Avalanche Energy[a] | | | $E_{AR}$ | 25 | mJ |
| Maximum Power Dissipation | $T_C$ = 25 °C | | $P_D$ | 250 | W |
| Peak Diode Recovery dV/dt[c] | | | dV/dt | 9.2 | V/ns |
| Operating Junction and Storage Temperature Range | | | $T_J$, $T_{stg}$ | - 55 to + 150 | °C |
| Soldering Recommendations (Peak Temperature) | for 10 s | | | 300[d] | |
| Mounting Torque | 6-32 or M3 screw | | | 10 | lbf · in |
| | | | | 1.1 | N · m |

**Notes**

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Starting $T_J$ = 25 °C, L = 5.7 mH, $R_g$ = 25 Ω, $I_{AS}$ =14 A, dV/dt = 7.6 V/ns (see fig. 12a).
c. $I_{SD}$ ≤ 14 A, dI/dt ≤ 250 A/μs, $V_{DD}$ ≤ $V_{DS}$, $T_J$ ≤ 150 °C.
d. 1.6 mm from case.

| THERMAL RESISTANCE RATINGS | | | | |
|---|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **TYP.** | **MAX.** | **UNIT** |
| Maximum Junction-to-Ambient | $R_{thJA}$ | - | 62 | °C/W |
| Case-to-Sink, Flat, Greasd Surface | $R_{thCS}$ | 0.50 | - | |
| Maximum Junction-to-Case (Drain) | $R_{thJC}$ | - | 0.50 | |

| **SPECIFICATIONS** ($T_J$ = 25 °C, unless otherwise noted) | | | | | | | |
|---|---|---|---|---|---|---|---|
| **PARAMETER** | **SYMBOL** | **TEST CONDITIONS** | | **MIN.** | **TYP.** | **MAX.** | **UNIT** |
| **Static** | | | | | | | |
| Drain-Source Breakdown Voltage | $V_{DS}$ | $V_{GS}$ = 0 V, $I_D$ = 250 µA | | 500 | - | - | V |
| $V_{DS}$ Temperature Coefficient | $\Delta V_{DS}/T_J$ | Reference to 25 °C, $I_D$ = 1 mA | | - | 0.55 | - | V/°C |
| Gate-Source Threshold Voltage | $V_{GS(th)}$ | $V_{DS}$ = $V_{GS}$, $I_D$ = 250 µA | | 2.0 | - | 4.0 | V |
| Gate-Source Leakage | $I_{GSS}$ | $V_{GS}$ = ± 20V | | - | - | ±100 | nA |
| Zero Gate Voltage Drain Current | $I_{DSS}$ | $V_{DS}$ = 500 V, $V_{GS}$ = 0 V | | - | - | 25 | µA |
| | | $V_{DS}$ = 400 V, $V_{GS}$ = 0 V, $T_J$ = 125 °C | | - | - | 250 | |
| Drain-Source On-State Resistance | $R_{DS(on)}$ | $V_{GS}$ = 10 V | $I_D$ = 8.4 A[b] | - | 0.660 | - | Ω |
| Forward Transconductance | $g_{fs}$ | $V_{DS}$ = 50 V, $I_D$ = 8.4 A | | 8.1 | - | - | S |
| **Dynamic** | | | | | | | |
| Input Capacitance | $C_{iss}$ | $V_{GS}$ = 0 V, $V_{DS}$ = 25 V, f = 1.0 MHz, see fig. 5 | | - | 1910 | - | pF |
| Output Capacitance | $C_{oss}$ | | | - | 290 | - | |
| Reverse Transfer Capacitance | $C_{rss}$ | | | - | 11 | - | |
| Output Capacitance | $C_{oss}$ | $V_{GS}$ = 0 V | $V_{DS}$ = 1.0 V, f = 1.0 MHz | - | 2730 | - | |
| | | | $V_{DS}$ = 400 V, f = 1.0 MHz | - | 82 | - | |
| Effective Output Capacitance | $C_{oss}$ eff. | | $V_{DS}$ = 0 V to 400 V[c] | - | 160 | - | |
| Total Gate Charge | $Q_g$ | $V_{GS}$ = 10 V | $I_D$ = 14 A, $V_{DS}$ = 400 V, see fig. 6 and 13[b] | - | - | 81 | nC |
| Gate-Source Charge | $Q_{gs}$ | | | - | - | 20 | |
| Gate-Drain Charge | $Q_{gd}$ | | | - | - | 36 | |
| Turn-On Delay Time | $t_{d(on)}$ | | $V_{DD}$ = 250 V, $I_D$ = 14 A, $R_g$ = 7.5 Ω, see fig. 10[b] | - | 15 | - | ns |
| Rise Time | $t_r$ | | | - | 39 | - | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | - | 39 | - | |
| Fall Time | $t_f$ | | | - | 31 | - | |
| **Drain-Source Body Diode Characteristics** | | | | | | | |
| Continuous Source-Drain Diode Current | $I_S$ | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 13 | A |
| Pulsed Diode Forward Current[a] | $I_{SM}$ | | | - | - | 56 | |
| Body Diode Voltage | $V_{SD}$ | $T_J$ = 25 °C, $I_S$ = 14 A, $V_{GS}$ = 0 V[b] | | - | - | 1.5 | V |
| Body Diode Reverse Recovery Time | $t_{rr}$ | $T_J$ = 25 °C, $I_F$ = 14 A, $T_J$ = 125 °C, dI/dt = 100 A/µs[b] | | - | 370 | 550 | ns |
| Body Diode Reverse Recovery Charge | $Q_{rr}$ | | | - | 4.4 | 6.5 | µC |
| Body Diode Reverse Recovery Current | $I_{RRM}$ | | | - | 21 | 31 | A |
| Forward Turn-On Time | $t_{on}$ | Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$) | | | | | |

**Notes**

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
b. Pulse width ≤ 300 µs; duty cycle ≤ 2 %.
c. $C_{oss}$ eff. is a fixed capacitance that gives the same charging time as $C_{oss}$ while $V_{DS}$ is rising from 0 % to 80 % $V_{DS}$.

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

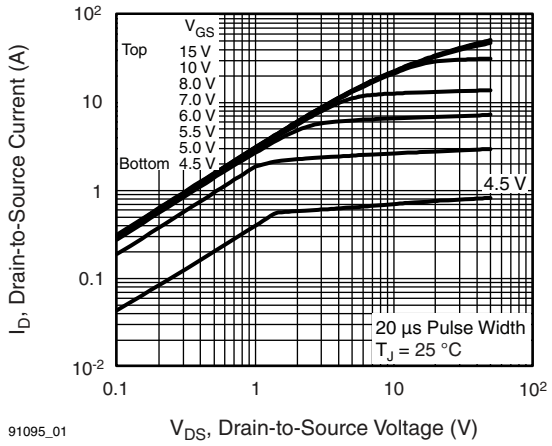



**Fig. 1 - Typical Output Characteristics**

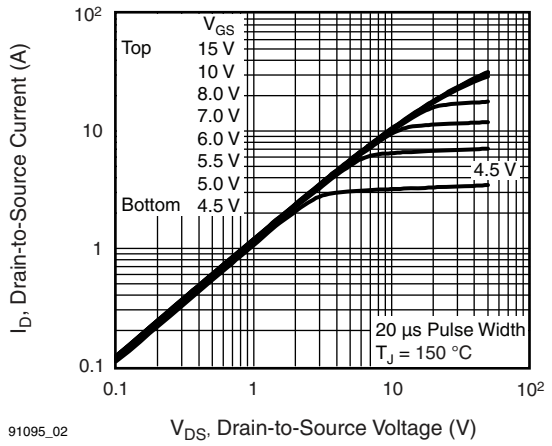



**Fig. 2 - Typical Output Characteristics**

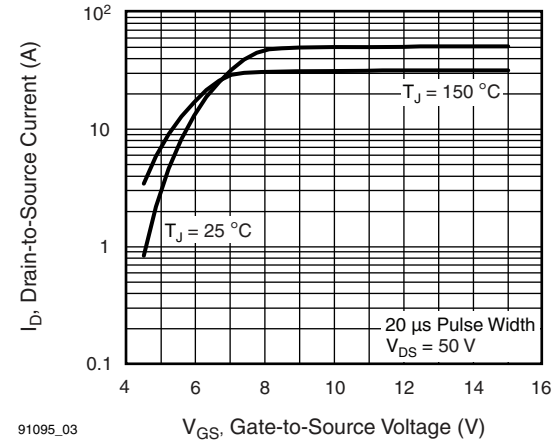



**Fig. 3 - Typical Transfer Characteristics**

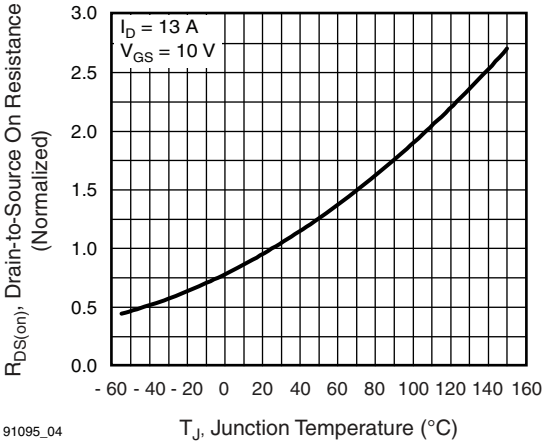



**Fig. 4 - Normalized On-Resistance vs. Temperature**

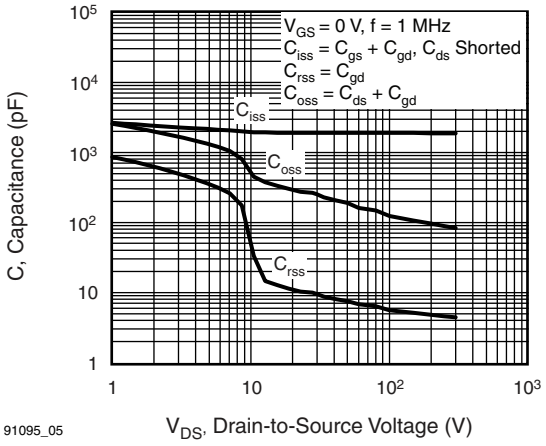



**Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage**

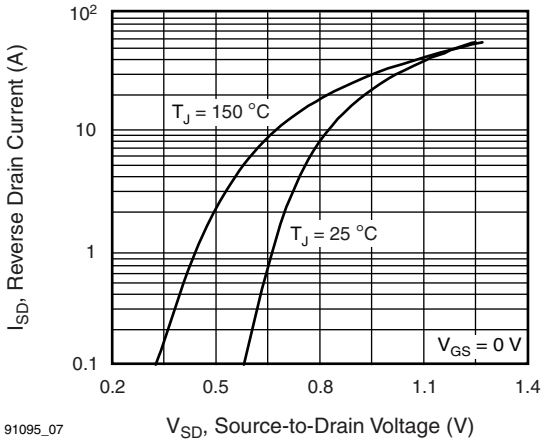



**Fig. 7 - Typical Source-Drain Diode Forward Voltage**

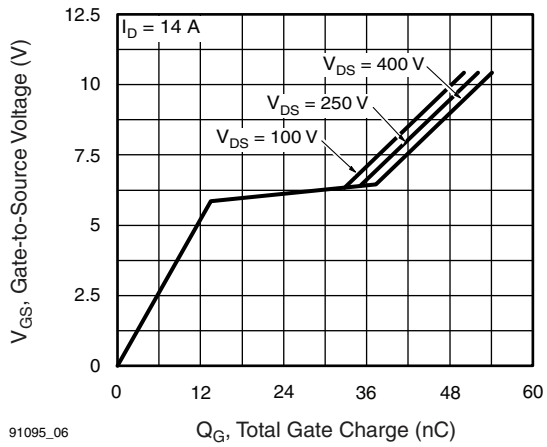



**Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage**

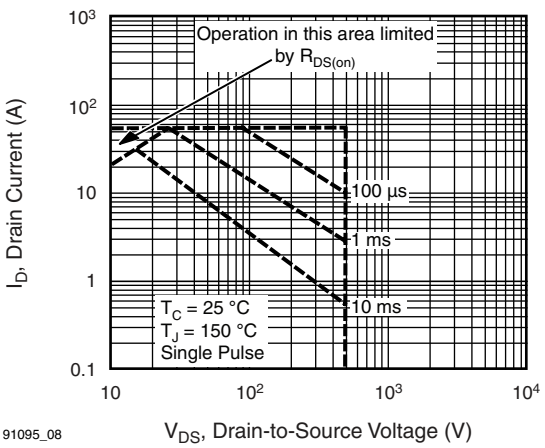



**Fig. 8 - Maximum Safe Operating Area**

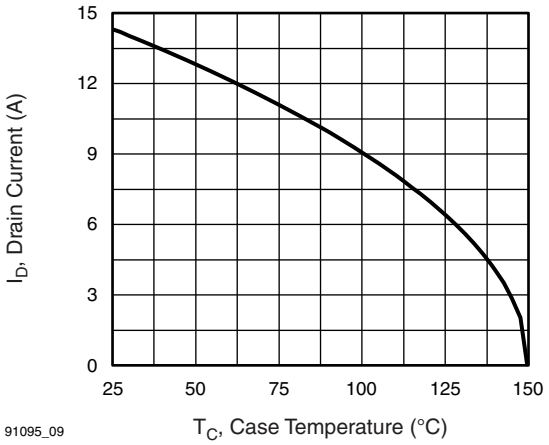



**Fig. 9 - Maximum Drain Current vs. Case Temperature**

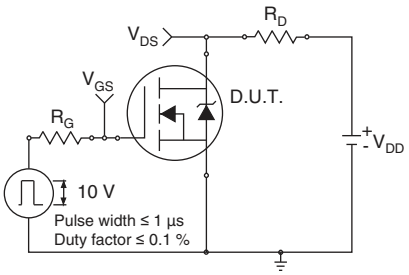



**Fig. 10a - Switching Time Test Circuit**

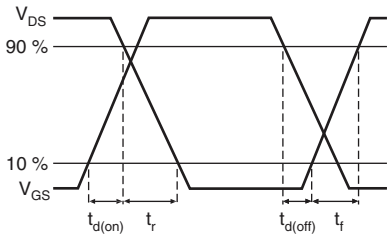



**Fig. 10b - Switching Time Waveforms**

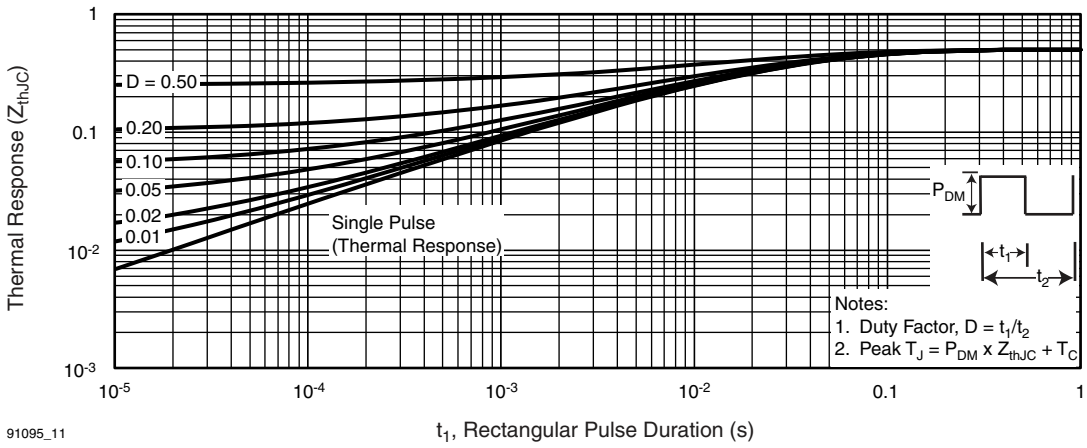



**Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case**

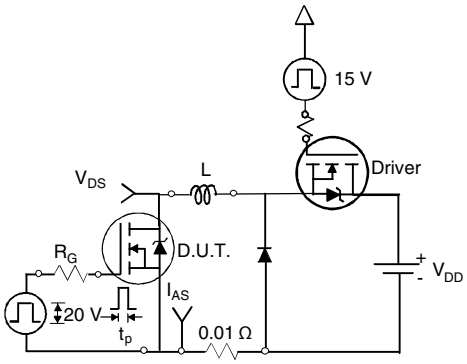



**Fig. 12a - Unclamped Inductive Test Circuit**

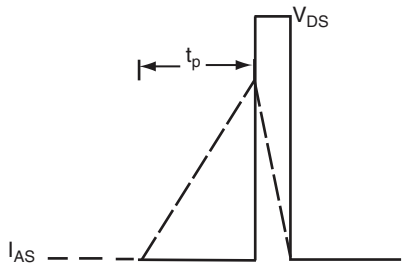



**Fig. 12b - Unclamped Inductive Waveforms**

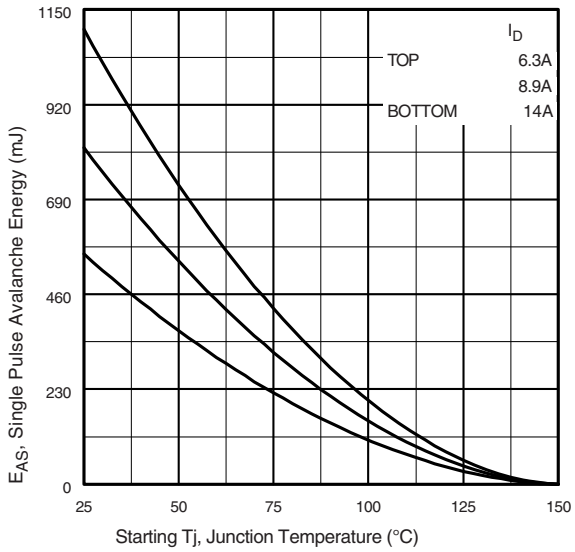



**Fig. 12c - Maximum Avalanche Energy vs. Drain Current**

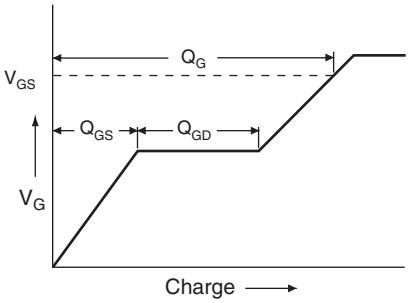



**Fig. 13a - Basic Gate Charge Waveform**

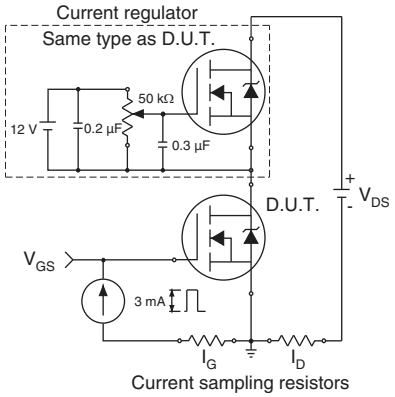
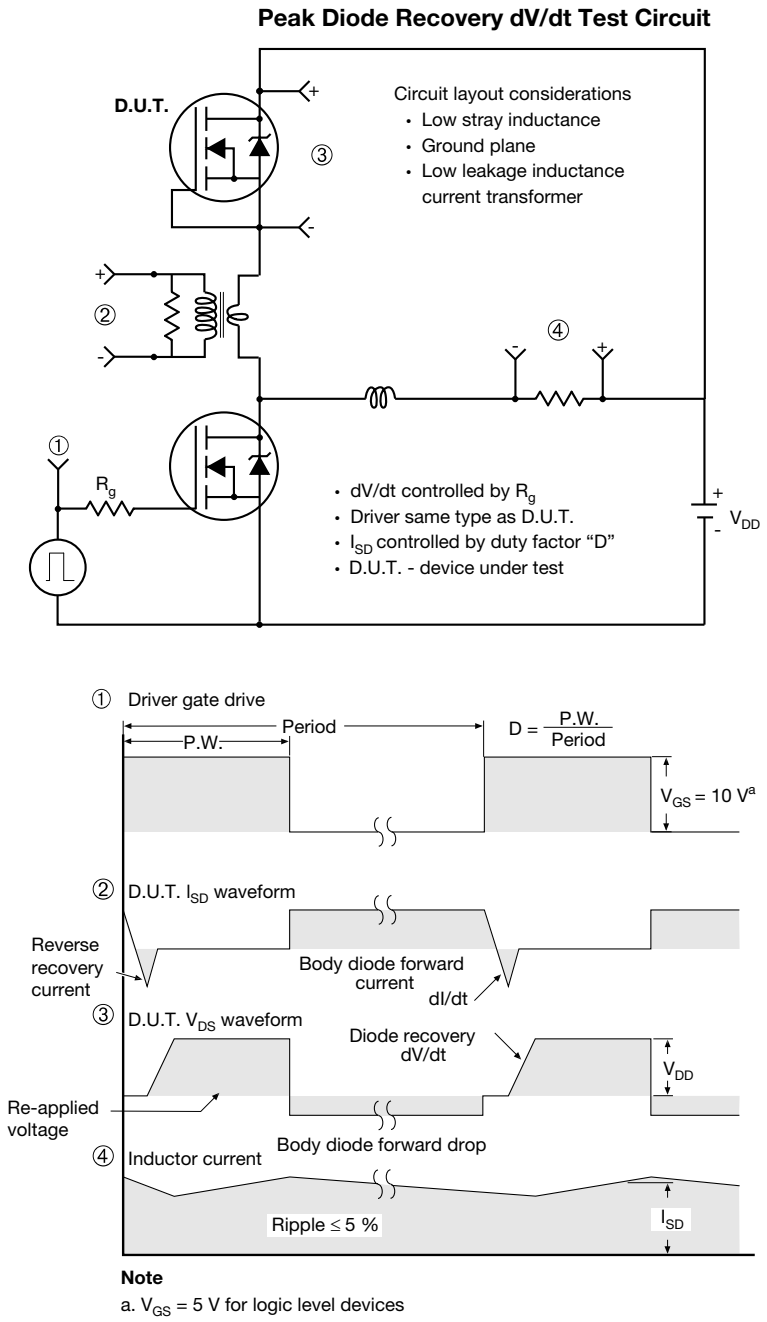



**Fig. 13b - Gate Charge Test Circuit**

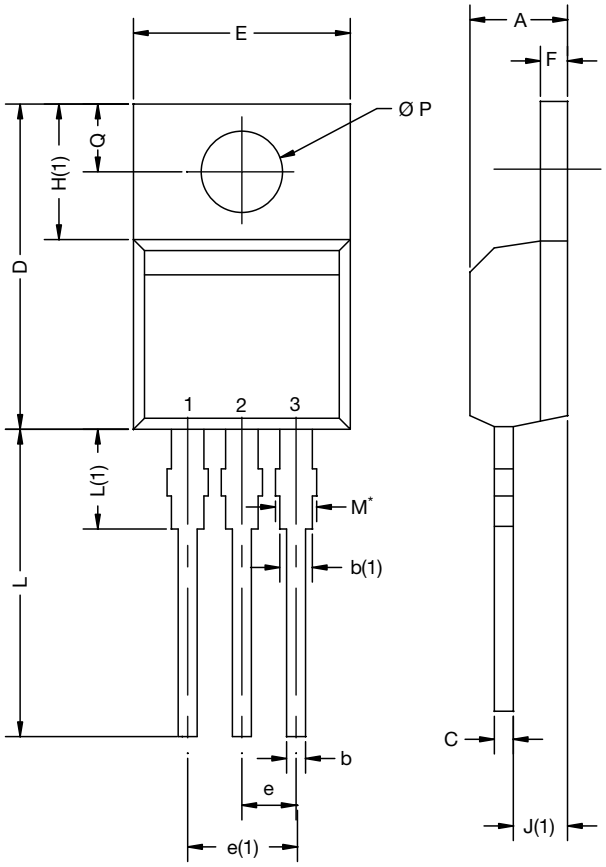



**Note**

a. $V_{GS}$ = 5 V for logic level devices

**Fig. 14 - For N-Channel**

# TO-220AB




| DIM. | MILLIMETERS | | INCHES | |
|---|---|---|---|---|
| | MIN. | MAX. | MIN. | MAX. |
| A | 4.24 | 4.65 | 0.167 | 0.183 |
| b | 0.69 | 1.02 | 0.027 | 0.040 |
| b(1) | 1.14 | 1.78 | 0.045 | 0.070 |
| c | 0.36 | 0.61 | 0.014 | 0.024 |
| D | 14.33 | 15.85 | 0.564 | 0.624 |
| E | 9.96 | 10.52 | 0.392 | 0.414 |
| e | 2.41 | 2.67 | 0.095 | 0.105 |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 |
| F | 1.14 | 1.40 | 0.045 | 0.055 |
| H(1) | 6.10 | 6.71 | 0.240 | 0.264 |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 |
| L | 13.36 | 14.40 | 0.526 | 0.567 |
| L(1) | 3.33 | 4.04 | 0.131 | 0.159 |
| Ø P | 3.53 | 3.94 | 0.139 | 0.155 |
| Q | 2.54 | 3.00 | 0.100 | 0.118 |
| ECN: X15-0364-Rev. C, 14-Dec-15<br>DWG: 6031 | | | | |

**Note**

- M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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